TIDA-00271 Test Image of a Color Chart
1.5m automotive coaxial cable from ADAS interconnect board to a remote camera module with Omnivision OV10635 camera EVM and serializer board
Picture resolution : 720P (1280x720)
Picture format is YUV420
Camera power consumption : app. 80mA-110mA @ 12V
TIDA-00271 Test Setup
1.5m automotive coaxial cable from ADAS interconnect board to a remote camera module with Omnivision OV10635 camera EVM and serializer board
Picture resolution: 720P (1280x720)
Picture format: YUV420
Camera power consumption: app. 80mA-110mA @ 9V

OV10635 Camera EVM (used for test)

Serializer Board with power (used for test)

TIDA-00262 Camera board

FPD-Link 3 with 1.4 Gbps and PoC
FPD-Link 3 with 3 Gbps data using STP
Parallel RGB to Processor

ADAS interconnect board to (used for test)

Power
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